Datasheet

# General purpose transistor (dual transistors)

Parameter	Tr1 and Tr2	
V <sub>CEO</sub>	12V	
I <sub>C</sub>	500mA	

#### Outline

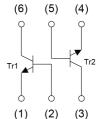
SOT-563	SOT-363
(6) (5) (4)	(1)
(2) (3)	(2)
EMX18	UMX18N
(EMT6)	(UMT6)

#### Features

- 1)Two 2SC5585 chips in a EMT or UMT package.
- 2)Mounting possible with EMT3 or UMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4) Mounting cost and area can be cut in half.

#### •Inner circuit

- (1) Tr1 Emitter
- (2) Tr1 Base
- (3) Tr2 Collector
- (4) Tr2 Emitter
- (5) Tr2 Base
- (6) Tr1 Collector



## Application

LOW FREQUENCY AMPLIFIER, DRIVER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMX18	SOT-563 (EMT6)	1616	T2R	180	8	8000	X18
UMX18N	SOT-363 (UMT6)	2021	TN	180	8	3000	X18

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

<It is the same ratings for the Tr1 and Tr2>

Parameter			Values	Unit
Collector-base voltage			15	V
Collector-emitter voltage			12	V
Emitter-base voltage			6	V
			500	mA
Collector current	Collector current		1.0	Α
Power dissipation	EMX18	D *2*3	150	107
UMX18N		P <sub>D</sub> *2*3	150	mW
Junction temperature			150	°C
Range of storage temperature			-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

<It is the same characteristics for the Tr1 and Tr2>

Davanastav	Company of	Conditions	Values			Linit
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = 10μA	15	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	12	-	-	V
Emitter-base breakdown voltage	$BV_{EBO}$	I <sub>E</sub> = 10μA	6	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 15V	-	1	100	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 6V	-	1	100	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 200mA, I <sub>B</sub> = 10mA	-	90	250	mV
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 2V, I <sub>C</sub> = 10mA	270	-	680	-
Transition frequency	f <sub>⊤</sub>	$V_{CE} = 2V, I_{E} = -10 \text{mA},$ f = 100MHz	-	320	-	MHz
Output capacitance	$C_ob$	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0A, f = 1MHz	-	7.5	-	pF

<sup>\*1</sup> Pw=1ms Single Pulse

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3 120</sup>mW per element must not be exceeded.

## ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>

Fig.1 Grounded emitter propagation characteristics

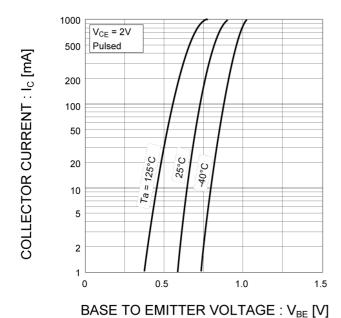
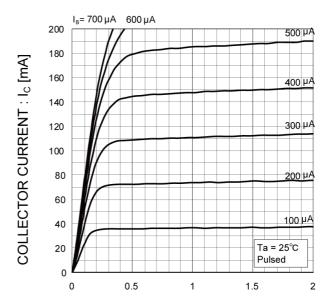


Fig.2 Typical output characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC current gain vs. collector current (I)

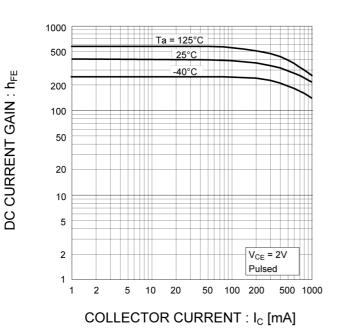
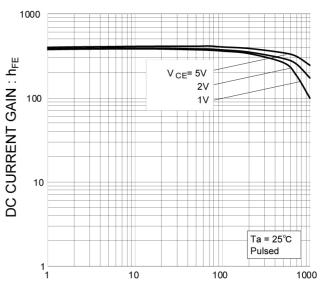


Fig.4 DC current gain vs. collector current (II)



COLLECTOR CURRENT : I<sub>C</sub> [mA]

EMX18 / UMX18N Datasheet

## ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>

Fig.5 Collector-emitter saturation voltage vs. collector current (I)

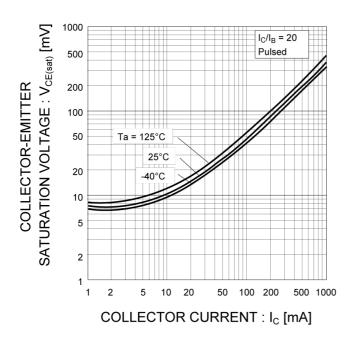


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

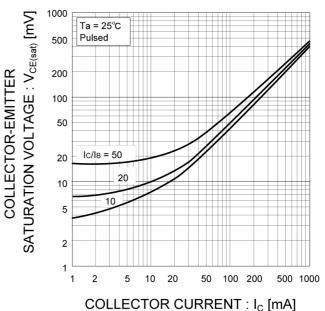


Fig.7 Base-emitter saturation voltage vs. collector current

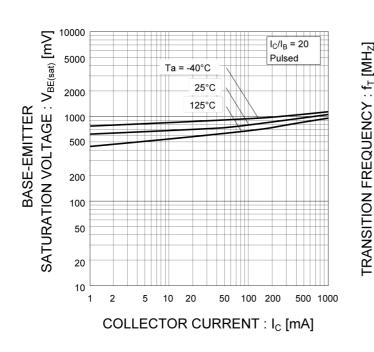
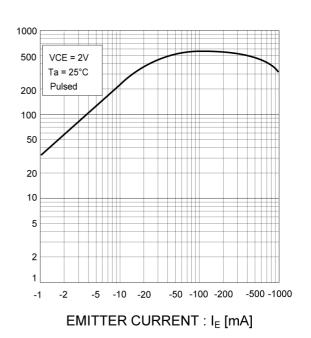


Fig.8 Gain bandwidth product vs. emitter current



# ● Electrical characteristic curves (T<sub>a</sub> =25°C)

<For Tr1 and Tr2 in common>

Fig.9 Collector output capacitance vs. collector-base voltage
Emitter input capacitance vs. emitter-base voltage

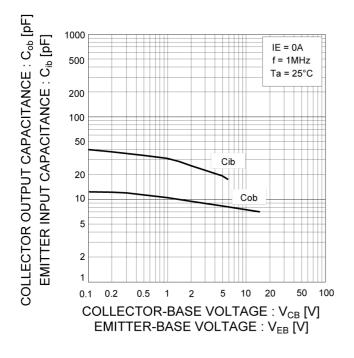


Fig.10 Safe Operating Area

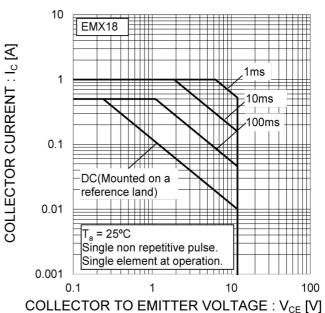
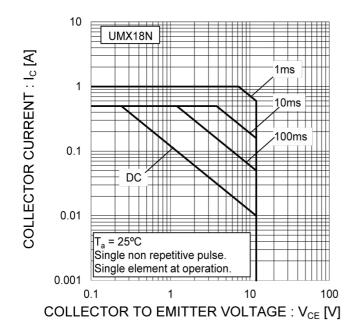
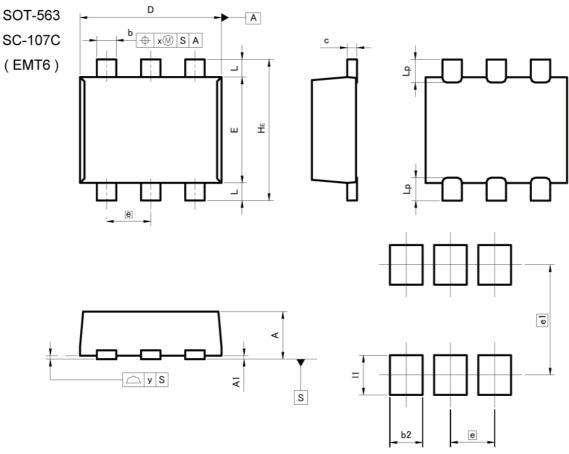


Fig.11 Safe Operating Area



### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

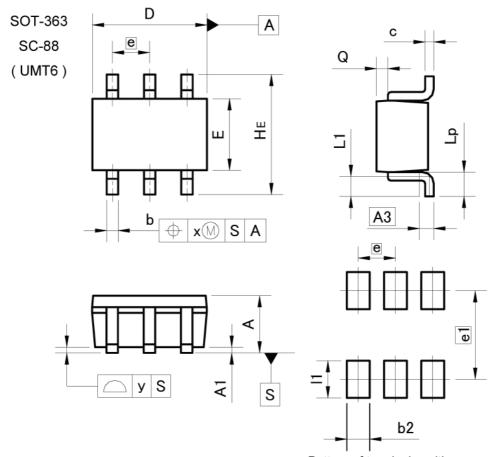
	MILIMETERS		INCHES		
DIM	IVITETIVI	ETERS	INCHES		
Diw	MIN	MAX	MIN	MAX	
Α	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
С	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.	50	0.020		
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	_	0.35	_	0.014	
х	-	0.10	_	0.004	
У	_	0.10	-	0.004	

	DIM	MILIMETERS		INCHES		
		MIN	MAX	MIN	MAX	
	b2	_	0.37	_	0.015	
	e1	1.25		0.0	49	
	- 11	-	0.45	-	0.018	

Dimension in mm/inches



### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.5	25	0.0	10
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.026	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.020
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	-	0.10	-	0.004
У		0.10	e <del>-</del>	0.004

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	- 1	0.40	-	0.016	
e1	1.	55	0.0	61	
11	-	0.65	-	0.026	

Dimension in mm/inches



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CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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